03-09-2007

Atty. Docket No .:	6661-000068/US
	Page 1 of 1

ĒT			
emarks:	 		

To the Hon Please recor. 1033	emarks: thereof.		
1. Name of conveying party(ies):	2. Name and address of receiving party(ies)		
Joo Young KIM	Name: SAMSUNG ELECTRONICS CO., LTD.		
Eun Kyung LEE	International Address: 416, Maetan-dong, Yeongtong-gu		
Sang Yoon LEE			
Bang Lin LEE			
Additional name(s) of conveying party(ies) attached? [] YES NO	City: Suwon-si State: Gyeonggi-do ZIP: Country: Korea Postal Code:		
3. Nature of conveyance:	,		
	Additional name(s) & address(es) attached? YES NO		
☐ Security Agreement ☐ Change of Name			
Other:			
Execution Date: January 18, 2007; January 18, 2007; January 18, 2007; and January 18, 2007, respectively			
4. Application number(s) or patent number(s):			
If this document is being filed together with a new application, th	e execution date of the application is:		
A. Patent Application No(s).	B. Patent No.(s).		
11/655,181			
Additional numbers attac	hed? 🔲 YES 🔯 NO		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total No. of applications/patents involved: One (1)		
-	7. Total fee (37 C.F.R. § 3.41): \$40.00		
Name: HARNESS, DICKEY & PIERCE, P.L.C.	☑ Enclosed☑ Authorized to be charged to deposit account,		
Street Address: P.O. BOX 8910			
City: RESTON State: VA ZIP: 20195	if no fee attached.		
Country: USA	8. Deposit account number: <u>08-0750</u>		
	(Attach triplicate copy of this page if paying by deposit account)		
DO NOT USE	THIS SPACE		

Signature

Total number of pages including cheer sheet, attachments, and document: Three (3)

03/08/2007 DBYRNE

9. Statement and signature.

copy of the original document.

00000018 11655181

John A. Castellano/35/094

Name of Person Signing/Reg. No.

01 FC:8021

To the best of my knowledge and belief, the foregoin

JAC:pw

March 6, 2007

PATENT REEL: 019011 FRAME: 0640

information is true and correct and any attached copy is a true

ASSIGNMENT

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

INSULATING ORGANIC POLYMER, ORGANIC INSULATING LAYER FORMED USING THE INSULATING POLYMER, AND ORGANIC THIN FILM TRANSISTOR COMPRISING THE INSULATING LAYER

for which Assignor is about to make or has made United States or International application for patent

(a)		executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney);
(b)		executed on,; or
(c)		filed on, and assigned Serial No or PCT International Application No;
(d)		U.S. Patent No, issued; and
\A/LIE	DEAC	Sameung Flactronics Co. Ltd. 416. Maetan-dong Vacantong-gu Sulvon si

WHEREAS, Samsung Electronics Co., Ltd., 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as Assignee, is desirous of acquiring an interest therein:

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy whereof is hereby acknowledged, Assignor by these presents does sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and all foreign countries, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the said invention as described in the aforesaid application, said application for patent and all Letters Patent therefor to be held and enjoyed by Assignee to the full end of the term for which said Letters Patent are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to recover for past infringements of, or liabilities for, any of the rights relating to any of said applications or patents resulting therefrom;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale or agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the Commissioner of Patents and Trademarks to issue said Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue said Letters Patent, Utility Model Registration or Inventor's Certificate to Assignee.

The undersigned hereby grant(s) the law firm of Harness, Dickey & Pierce, P.L.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

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REEL: 019011 FRAME: 0641

ASSIGNMENT

Joo Young Kilm

January 18, 2007

Dated

lunice

Eun Kyung LEE

January 18, 2007

Dated

Sang Yoon LEE

January 18, 2007

Dated

Bang Lin LEE

January 18, 2007

Dated

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PATENT REEL: 019011 FRAME: 0642

RECORDED: 03/06/2007